

L Number	Hits	Search Text	DB	Time stamp
1	13354	substrate with sapphire	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/18 09:03
2	654	(substrate with sapphire) and (group adj III adj nitride)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/18 09:03
3	139	((substrate with sapphire) and (group adj III adj nitride)) and ((group adj III adj nitride) with (mocvd or sputter\$4 or evaporat\$4 or (ion adj plat\$4) or (laser adj ablat\$4) or ecr))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/18 09:28
4	49	((substrate with sapphire) and (group adj III adj nitride)) and ((group adj III adj nitride) with (mocvd or sputter\$4 or evaporat\$4 or (ion adj plat\$4) or (laser adj ablat\$4) or ecr))) and temperature\$2 and (flow adj rate\$2)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/18 09:22
5	60	((substrate with sapphire) and (group adj III adj nitride)) and ((group adj III adj nitride) with (mocvd or sputter\$4 or evaporat\$4 or (ion adj plat\$4) or (laser adj ablat\$4) or ecr))) and (aln same sputter\$4)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/18 09:23
6	65	((substrate with sapphire) and (group adj III adj nitride)) and ((group adj III adj nitride) with (sputter\$4 or evaporat\$4 or (ion adj plat\$4) or (laser adj ablat\$4) or ecr))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/18 09:33
7	18	((substrate with sapphire) and (group adj III adj nitride)) and ((group adj III adj nitride) with (sputter\$4 or evaporat\$4 or (ion adj plat\$4) or (laser adj ablat\$4) or ecr))) not (((substrate with sapphire) and (group adj III adj nitride)) and ((group adj III adj nitride) with (mocvd or sputter\$4 or evaporat\$4 or (ion adj plat\$4) or (laser adj ablat\$4) or ecr))) and (aln same sputter\$4))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/18 09:28
8	64	((substrate with sapphire) and (group adj III adj nitride)) and ((group adj III adj nitride) with (sputter\$4 or evaporat\$4 or (ion adj plat\$4) or (laser adj ablat\$4) or ecr))) and ((group adj III adj nitride) with (method or process))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/18 09:33